

15KPA Series



Agency Approvals

AGENCY	AGENCY FILE NUMBER
	E128662/E230531

Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation by 10x1000µs Test Waveform (Fig.2) (Note 1)	P _{PPM}	15000	W
Steady State Power Dissipation on Infinite Heat Sink at T _L =75°C (Fig. 6)	P _D	8.0	W
Peak Forward Surge Current, 8.3ms Single Half Sine Wave Unidirectional Only (Note 2)	I _{FSM}	400	A
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to 175	°C
Typical Thermal Resistance Junction to Lead	R _{uJL}	8.0	°C/W
Typical Thermal Resistance Junction to Ambient	R _{uJA}	40	°C/W

Notes:

1. Non-repetitive current pulse, per Fig. 4 and derated above T_A = 25°C per Fig. 3.
2. Measured on 8.3ms single half sine wave or equivalent square wave, duty cycle=4 per minute maximum.

Functional Diagram



Description

The 15KPA Series is designed specifically to protect sensitive electronic equipment from voltage transients induced by lightning and other transient voltage events.

Features

- Typical maximum temperature coefficient $\Delta V_{BR} = 0.1\% \times V_{BR}@25^\circ\text{C} \times \Delta T$
- Glass passivated chip junction in P600 package
- 15000W peak pulse capability at 10x1000µs waveform, repetition rate (duty cycles):0.01%
- Fast response time: typically less than 1.0ps from 0 Volts to BV min
- Excellent clamping capability
- Typical failure mode is short from over-specified voltage or current
- Whisker test is conducted based on JEDEC JESD201A per its table 4a and 4c
- IEC-61000-4-2 ESD 15kV(Air), 8kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC801-2)
- EFT protection of data lines in accordance with IEC 61000-4-4 (IEC801-4)
- Low incremental surge resistance
- Typical I_R less than 2µA above 36V
- High temperature soldering guaranteed: 260°C/40 seconds / 0.375", (9.5mm) lead length, 5 lbs., (2.3kg) tension
- Plastic package has underwriters laboratory flammability classification 94V-0
- Matte tin lead-free plated
- Halogen free and RoHS compliant

Applications

TVS devices are ideal for the protection of I/O interfaces, V_{CC} bus and other vulnerable circuits used in telecom, computer, industrial and consumer electronic applications.

Electrical Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

Part Number (Uni)	Part Number (Bi)	Reverse Stand off Voltage V_R (Volts)	Breakdown Voltage V_{BR} (Volts) @ I_T		Test Current I_T (mA)	Maximum Peak Pulse Current I_{PP} (A)	Maximum Reverse Leakage $I_R @ V_R$ (μA)	Maximum Clamping Voltage $V_C @ I_{PP}$ (V)	Agency Approval 
			MIN	MAX					
15KPA17A	15KPA17CA	17	18.99	20.79	50	515.4	5000	29.3	X
15KPA18A	15KPA18CA	18	20.11	22.01	50	488.7	5000	30.9	X
15KPA20A	15KPA20CA	20	22.34	24.46	20	440.2	1500	34.3	X
15KPA22A	15KPA22CA	22	24.57	26.91	10	407.0	500	37.1	X
15KPA24A	15KPA24CA	24	26.81	29.35	5	371.0	150	40.7	X
15KPA26A	15KPA26CA	26	29.04	31.80	5	343.2	50	44.0	X
15KPA28A	15KPA28CA	28	31.28	34.24	5	317.9	25	47.5	X
15KPA30A	15KPA30CA	30	33.51	36.7	5	297.8	15	50.7	X
15KPA33A	15KPA33CA	33	36.9	40.4	5	276.1	2	54.7	X
15KPA36A	15KPA36CA	36	40.2	44.0	5	252.5	2	59.8	X
15KPA40A	15KPA40CA	40	44.7	48.9	5	229.5	2	65.8	X
15KPA43A	15KPA43CA	43	48.0	52.6	5	216.3	2	69.8	X
15KPA45A	15KPA45CA	45	50.3	55.0	5	207.4	2	72.8	X
15KPA48A	15KPA48CA	48	53.6	58.7	5	194.3	2	77.7	X
15KPA51A	15KPA51CA	51	57.0	62.4	5	182.1	2	82.9	X
15KPA54A	15KPA54CA	54	60.3	66.0	5	172.2	2	87.7	X
15KPA58A	15KPA58CA	58	64.8	70.9	5	161.0	2	93.8	X
15KPA60A	15KPA60CA	60	67.0	73.4	5	155.0	2	97.4	X
15KPA64A	15KPA64CA	64	71.5	78.3	5	144.9	2	104.2	X
15KPA70A	15KPA70CA	70	78.2	85.6	5	132.9	2	113.6	X
15KPA75A	15KPA75CA	75	83.8	91.7	5	123.8	2	122.0	X
15KPA78A	15KPA78CA	78	87.1	95.4	5	119.7	2	126.1	X
15KPA85A	15KPA85CA	85	94.9	104.0	5	109.7	2	137.6	X
15KPA90A	15KPA90CA	90	100.5	110.1	5	103.7	2	145.6	X
15KPA100A	15KPA100CA	100	111.7	122.3	5	93.6	2	161.3	X
15KPA110A	15KPA110CA	110	122.9	134.5	5	84.5	2	178.6	X
15KPA120A	15KPA120CA	120	134.0	146.8	5	78.5	2	192.3	X
15KPA130A	15KPA130CA	130	145.2	159.0	5	72.5	2	208.3	X
15KPA150A	15KPA150CA	150	167.6	183.5	5	62.4	2	241.9	X
15KPA160A	15KPA160CA	160	178.7	195.7	5	58.4	2	258.6	X
15KPA170A	15KPA170CA	170	189.9	207.9	5	55.4	2	272.7	X
15KPA180A	15KPA180CA	180	201.1	220.1	5	52.3	2	288.5	X
15KPA200A	15KPA200CA	200	223.4	244.6	5	47.3	2	319.1	X
15KPA220A	15KPA220CA	220	245.7	269.1	5	42.4	2	356.0	X
15KPA240A	15KPA240CA	240	268.1	293.5	5	39.3	2	384.6	X
15KPA260A	15KPA260CA	260	290.4	318.0	5	36.2	2	416.7	X
15KPA280A	15KPA280CA	280	312.8	342.4	5	33.2	2	454.5	X

For bidirectional type having V_R of 30 volts and less, the I_R limit is double.

For parts without A, the V_{BR} is $\pm 10\%$ and V_C is 5% higher than with A parts

I-V Curve Characteristics



P_{PPM} Peak Pulse Power Dissipation – Max power dissipation

V_R Stand-off Voltage – Maximum voltage that can be applied to the TVS without operation

V_{BR} Breakdown Voltage – Maximum current that flows through the TVS at a specified test current (I_T)

V_C Clamping Voltage – Peak voltage measured across the suppressor at a specified I_{ppm} (peak impulse current)

I_R Reverse Leakage Current – Current measured at V_R

V_F Forward Voltage Drop for Uni-directional

Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted)

Figure 1 - TVS Transients Clamping Waveform



Figure 2 - Peak Pulse Power Rating Curve



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Ratings and Characteristic Curves ($T_A=25^\circ\text{C}$ unless otherwise noted) (Continued)

Figure 3 - Pulse Derating Curve

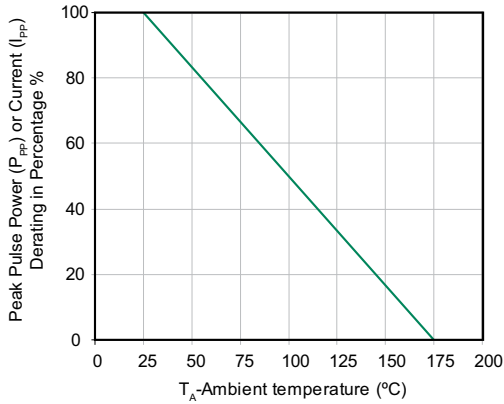


Figure 4 - Test Pulse Waveform

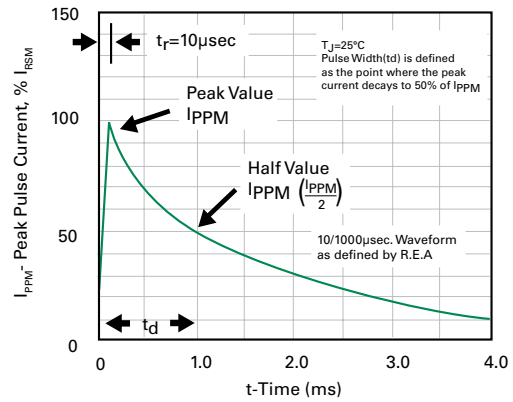


Figure 5 - Typical Junction Capacitance

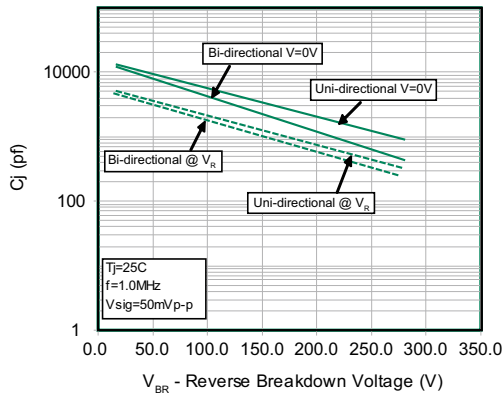


Figure 6 - Steady State Power Derating Curve

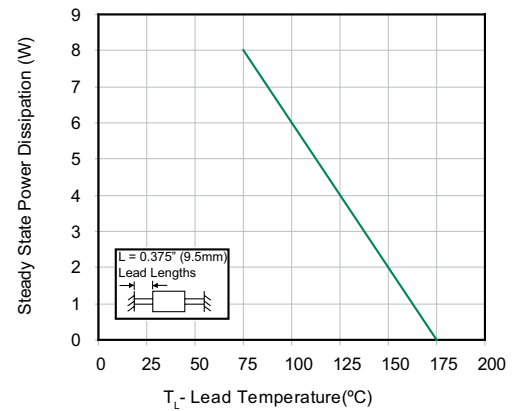
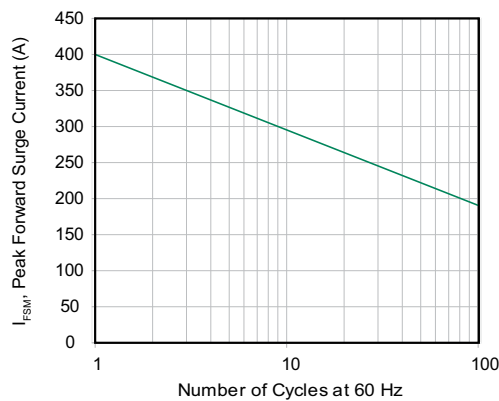
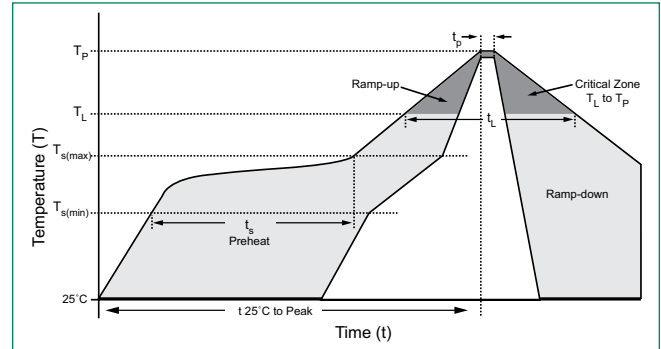


Figure 7 - Maximum Non-Repetitive Forward Surge Current



Soldering Parameters

Reflow Condition		Lead-free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Time (min to max) (t_s)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		280°C



Flow/Wave Soldering (Solder Dipping)

Peak Temperature :	265°C
Dipping Time :	10 seconds
Soldering :	1 time

Physical Specifications

Weight	0.07oz., 2.5g
Case	P600 molded plastic body over passivated junction.
Polarity	Color band denotes the cathode except Bipolar.
Terminal	Matte Tin axial leads, solderable per JESD22-B102D.

Environmental Specifications

Temperature Cycle	JESD22-A104
Pressure Cooker	JESD 22-A102
High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Thermal Shock	JESD22-A106

Dimensions



Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	1.000	-	25.40	-
B	0.340	0.360	8.60	9.10
C	0.048	0.052	1.22	1.32
D	0.340	0.360	8.60	9.10

Part Numbering System



Part Marking System



Packing Options

Part Number	Component Package	Quantity	Packaging Option	Packaging Specification
15KPAxxxXX	P600	800	Tape & Reel	EIA STD RS-296E
15KPAxxxXX-B	P600	100	Bulk	Littelfuse Concord Packing Spec. DM-0016

Tape and Reel Specification



Dimensions are in inches/mm

Данный компонент на территории Российской Федерации

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Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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